

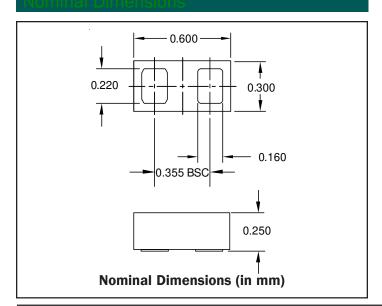
RClamp1851Y Ultra Small RailClamp® 1-Line, 18V ESD Protection

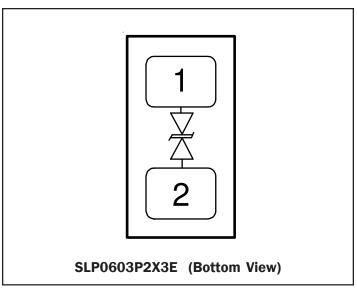
RailClamp® TVS diodes are ultra low capacitance devices designed to protect sensitive electronics from damage or latch-up due to ESD, EFT, and EOS. They are designed for use on high speed ports in applications such as cell phones, notebook computers, and other portable electronics. These devices offer desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

RClamp®1851Y is specifically designed for protection of Near Field Communications (NFC) interfaces. It features extremely good ESD protection characteristics including a low typical dynamic resistance of <0.1 Ohms, low peak ESD clamping voltage, and high ESD withstand voltage (+/-18kV contact per IEC 61000-4-2). Low typical capacitance (0.35pF at VR=0V) means that RClamp1851Y will not create harmonic distortion in the RF signal. This device is bidirectional and has a working voltage of 18V for use on NFC resonator circuits without signal clipping. RClamp1851Y is in a 2-pin SLP0603P2X3E package measuring 0.6 x 0.3 mm with a nominal height of 0.25mm. Leads are finished with lead-free NiAu. The combination of working voltage, low dynamic resistance, and low capacitance makes this device ideal for use on NFC antenna ciruits, signal lines, and FM antennas in portable devices.

Features

- ◆ High ESD withstand Voltage: +/-18kV (Contact/Air) per IEC 61000-4-2
- ◆ Able to withstand over 1000 ESD strikes per IEC 61000-4-2 Level 4
- Ultra-small 0201 package
- Protects one high speed data line
- ◆ Working voltage: +/- 18V
- Low capacitance: 0.35pF typical
- ◆ Extremely low dynamic resistance: <0.10 Ohms (Typ)
- Low ESD clamping voltage
- ◆ Solid-state silicon-avalanche technology
- ◆ SLP0603P2X3E Package
- Pb-Free, Halogen Free, RoHS/WEEE Compliant
- ◆ Nominal Dimensions: 0.6 x 0.3 x 0.25 mm
- Lead Finish: NiAu
- Marking: Marking Code
- ◆ Packaging: Tape and Reel
- ◆ Near Field Communication (NFC) lines
- RF signal lines
- ◆ FM Antenna







| Absolute Maximum Rating | | | | | |
|--|------------------|------------------|-------|--|--|
| Rating | Symbol | Value | Units | | |
| Peak Pulse Power (tp = 8/20μs) | P _{pk} | 60 | Watts | | |
| Maximum Peak Pulse Current (tp = 8/20μs) | I _{pp} | 3 | Amps | | |
| ESD per IEC 61000-4-2 (Air) ¹ ESD per IEC 61000-4-2 (Contact) ¹ | V _{ESD} | +/- 18 +/- 18 | kV | | |
| Operating Temperature | T, | -40 to +85 | °C | | |
| Storage Temperature | T _{STG} | -55 to +150 | °C | | |

| Parameter | Symbol | Conditions | Minimum | Typical | Maximum | Units |
|------------------------------------|-------------------|--|---------|---------|---------|-------|
| Reverse Stand-Off Voltage | V _{RWM} | Pin 1 to 2 or 2 to 1 | | | 18 | V |
| Trigger Voltage ² | V _{TRIG} | tp = 0.2/100ns | | 23 | | V |
| Reverse Leakage Current | I _R | V _{RWM} = 18V, T=25°C Pin 1 to 2 or 2 to 1 | | <1 | 50 | nA |
| ESD Clamping Voltage ² | V _c | $I_{pp} = 4A,$ tlp = 0.2/100ns | | 11 | | V |
| ESD Clamping Voltage ² | V _c | I _{PP} = 16A, tlp = 0.2/100ns | | 12 | | V |
| Dynamic Resistance ^{2, 3} | R _D | tp = 0.2/100ns | | 0.08 | | Ohms |
| Junction Capacitance | C _j | $V_R = OV, f = 1MHz$ | | 0.35 | 0.45 | pF |

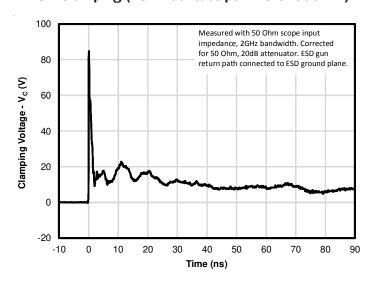
Notes

- 1)ESD gun return path connected to ESD ground reference plane.
- 2)Transmission Line Pulse Test (TLP) Settings: $t_p = 100$ ns, $t_r = 0.2$ ns, I_{TLP} and V_{TLP} averaging window: $t_1 = 70$ ns to $t_2 = 90$ ns.
- 3) Dynamic resistance calculated from $I_{TLP} = 4A$ to $I_{TLP} = 16A$

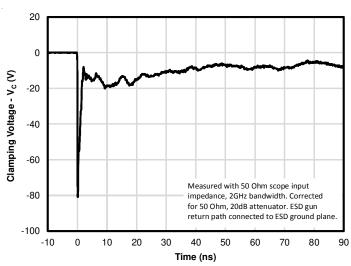


Typical Characteristics

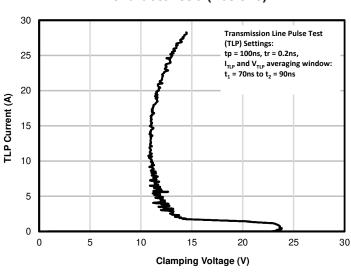
ESD Clamping (+8kV Contact per IEC 61000-4-2)



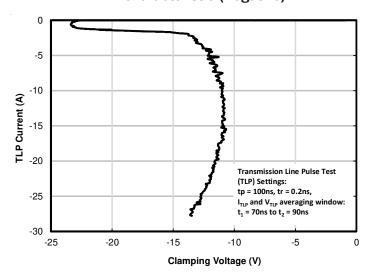
ESD Clamping (-8kV Contact per IEC 61000-4-2)



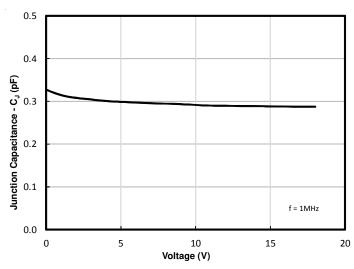
TLP Characteristic (Positive)



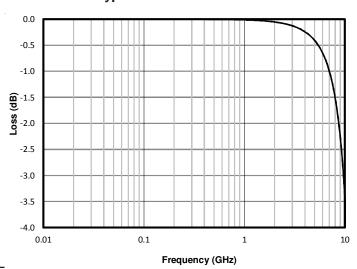
TLP Characteristic (Negative)



Junction Capacitance vs. Reverse Voltage



Typical Insertion Loss S21





ESD Protection of NFC Interfaces

The Near Field Communication (NFC) antenna is usually connected to the NFC controller IC via contact points on the phone. These contact points are user accessable and therefore may be subjected to ESD strikes. External protection (TVS) devices should be placed between the antenna and the NFC chip interface. The working voltage of the TVS should be high enough as not to clip the NFC signal. Additionaly, the capacitance of the device should be minimized in order to avoid harmonic disctortion of the RF signal. RClamp1851Y meets these requirements and also features extremely low dynamic resistance (<0.1 Ohms) resulting in low ESD clamping voltage. The low dynamic resistance also helps insure protection for Schottky diodes that may be used in the NFC circuit. RClamp1851Y is designed to work on NFC circuits with AC signals as high as 18V. An example protection ciruit using RClamp1851Y is shown below in Figure 1.

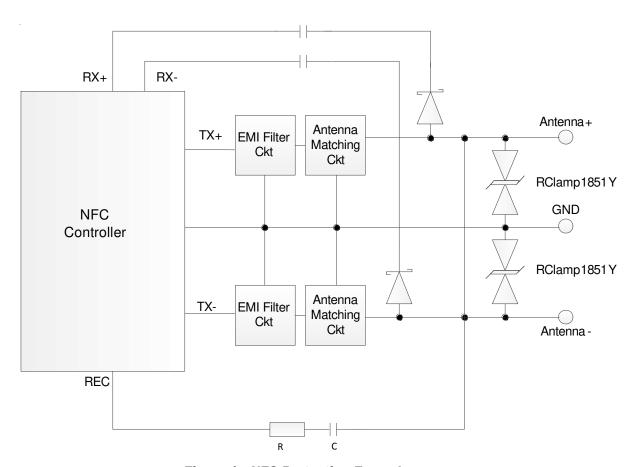


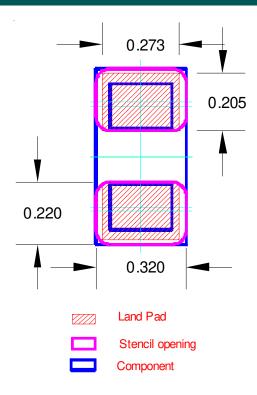
Figure 1 - NFC Protection Example



Assembly Guidelines

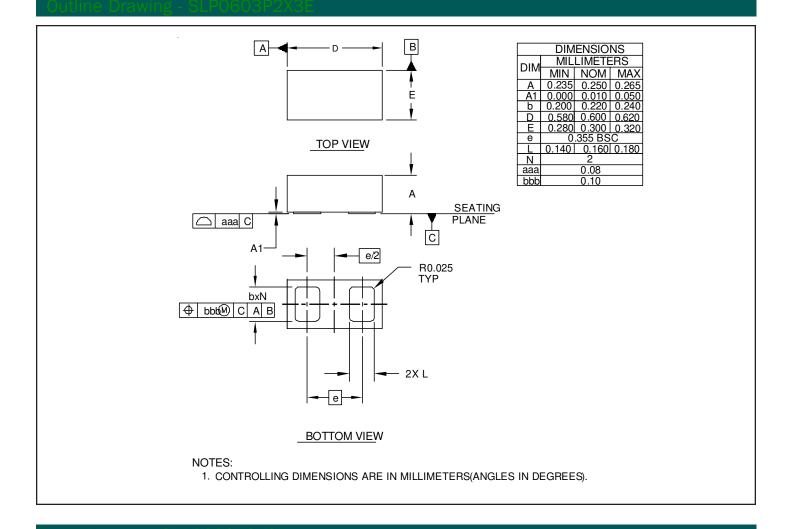
The small size of this device means that some care must be taken during the mounting process to insure reliable solder joints. The figure at the right details Semtech's recommended aperture based on the assembly guidelines detailed in the table below. Note that these are only recommendations and should serve only as a starting point for design since there are many factors that affect the assembly process. Exact manufacturing parameters will require some experimentation to get the desired solder application.

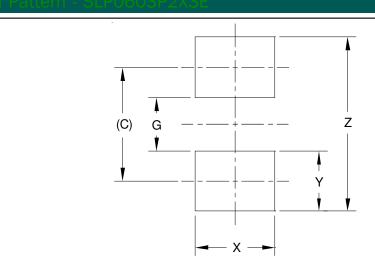
| Assembly Parameter | Recommendation | |
|--------------------------|----------------------------------|--|
| Solder Stencil Design | Laser cut, Electro-polished | |
| Aperture shape | Rectangular with rounded corners | |
| Solder Stencil Thickness | 0.100 mm (0.004") | |
| Solder Paste Type | Type 4 size sphere or smaller | |
| Solder Reflow Profile | Per JEDEC J-STD-020 | |
| PCB Solder Pad Design | Non-Solder mask defined | |
| PCB Pad Finish | OSP OR NiAu | |



Recommended Mounting Pattern





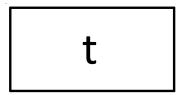


| DIMENSIONS | | |
|------------|-------------|--|
| DIM | MILLIMETERS | |
| С | (0.385) | |
| G | 0.181 | |
| Χ | 0.273 | |
| Υ | 0.205 | |
| 7 | 0.590 | |

NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY . CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET .





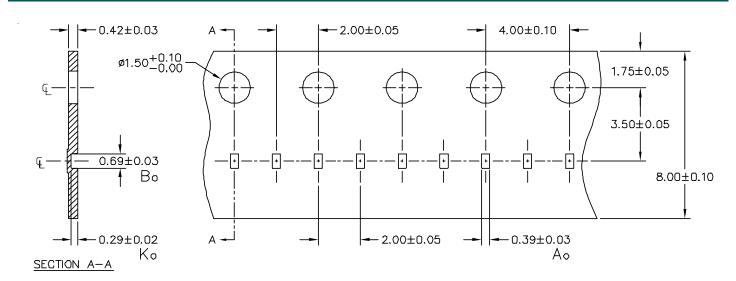
| Part Number | Qty per | Pocket | Reel |
|-----------------|---------|--------|--------|
| | Reel | Pitch | Size |
| RClamp1851Y.TFT | 15,000 | 2mm | 7 Inch |

Notes:

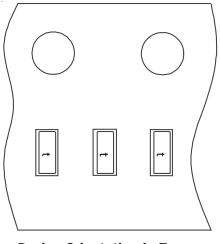
RailClamp and RClamp are trademarks of Semtech Corporation

Note: Device is electrically symmetrical

Carrier Tane Specification



NOTES: ALL DIMENSIONS IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.



Device Orientation in Tape



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